

## MSE-649 Seminar

# Assembly Techniques to Fabricate 2D Heterostructures

Presenters:

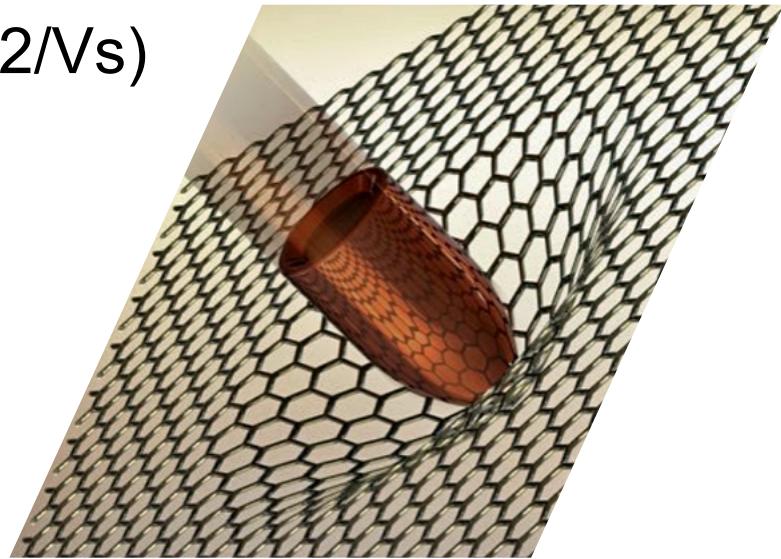
Aqeel Ahmed

Akshay Balgarkashi

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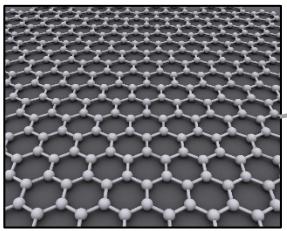
# What is a 2D material?

- Graphene as an example:
  - Best electrical conductor (RT mobility 100.000 cm<sup>2</sup>/Vs)
  - Strongest material (Strength 130 GPa)
  - Exceptional heat conductor (2000 W/mK)
  - Almost transparent (absorbance 2%)
  - Light weight and flexible (Stretchability (20%))
  - Unique physics
    - Electrons behave as massless particles
    - Klein tunneling
    - Half-integer quantum Hall effect



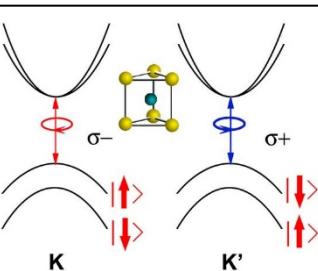
# History

## Graphene Nobel Prize



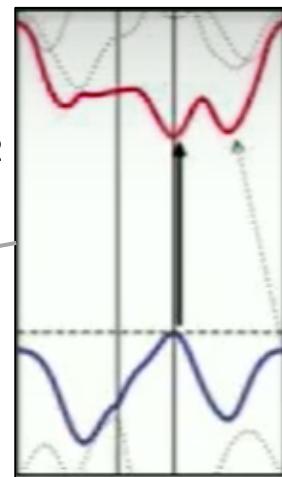
2004

Isolation of graphene

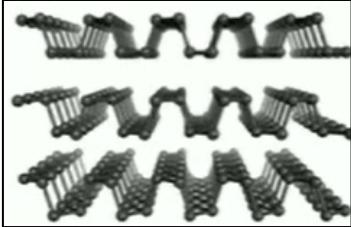


2010  
Valley polarization  
In MoS<sub>2</sub>

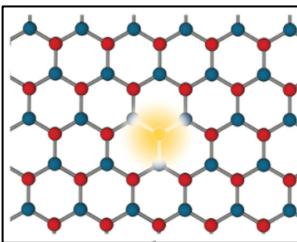
Direct-indirect  
Transition in MoS<sub>2</sub>



Isolation of phosphorene

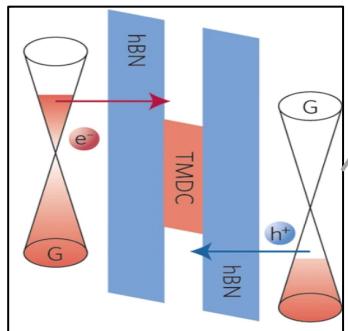


2014

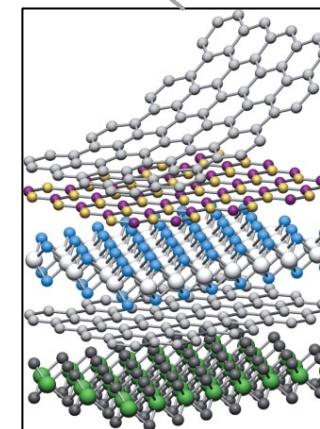


2D quantum  
emitters

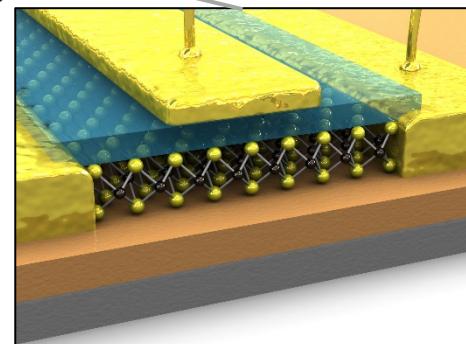
Light-emitting  
diode



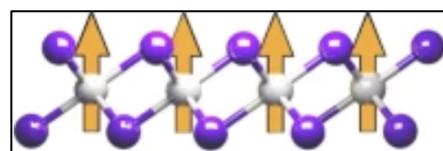
2015



Van der Waals  
heterostructures



MoS<sub>2</sub> transistor



First 2D ferromagnet (CrI<sub>3</sub>)

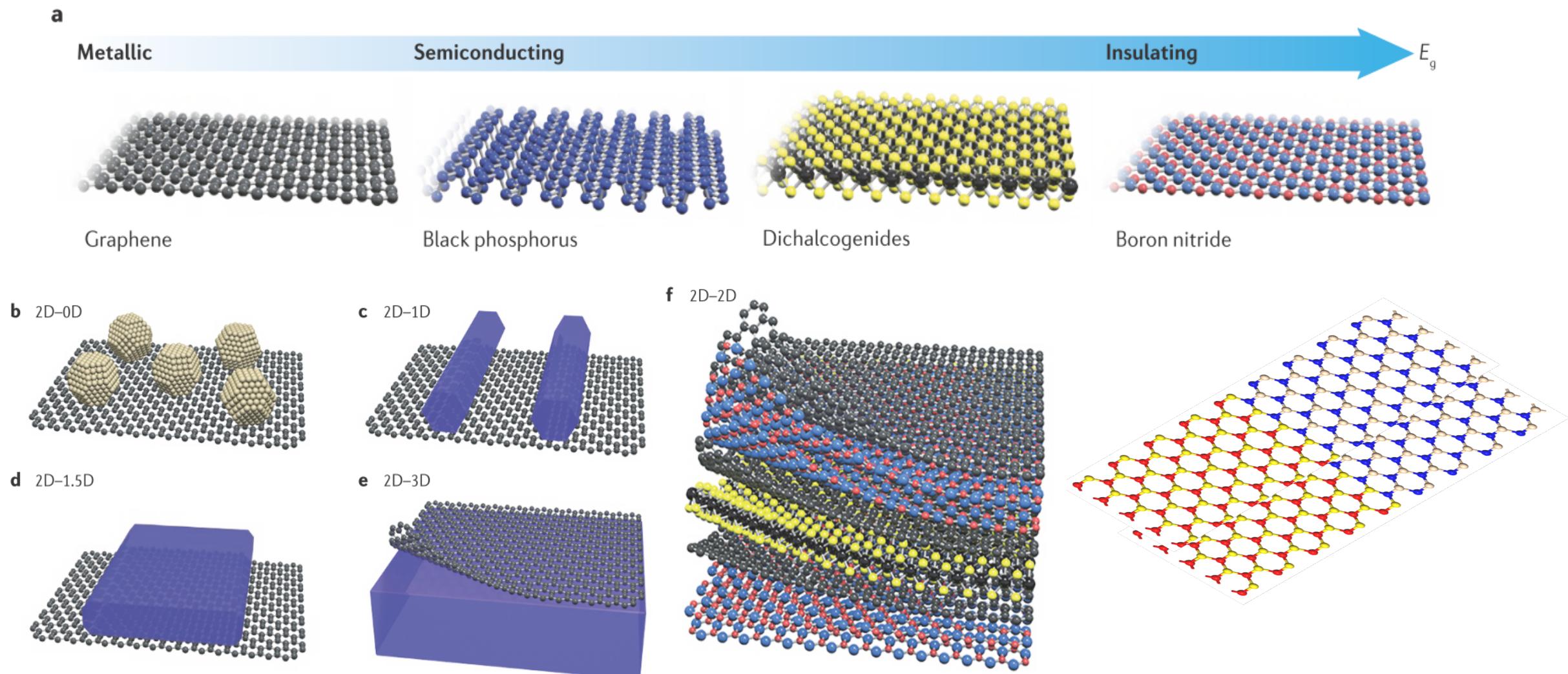
2017

2019-2020

CMOS compatible  
2D materials &  
wearable electronics

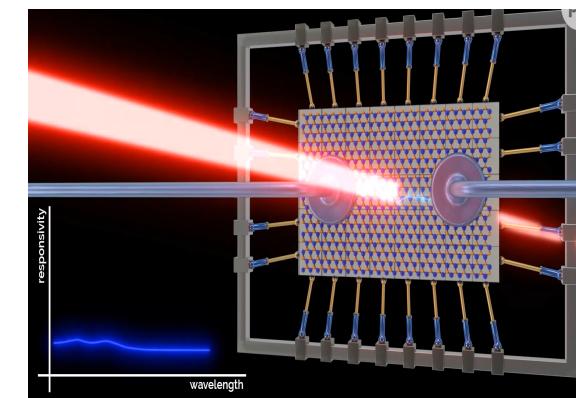
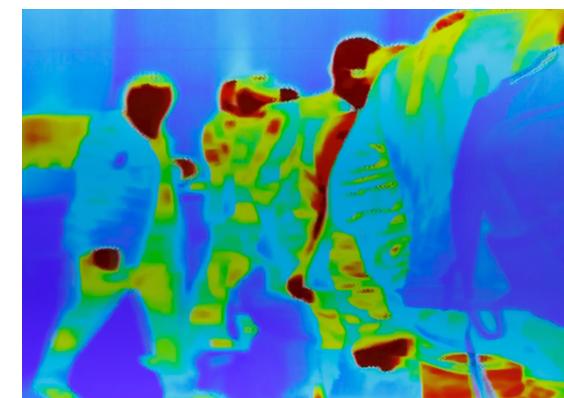
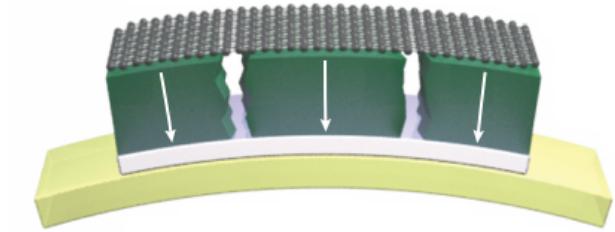
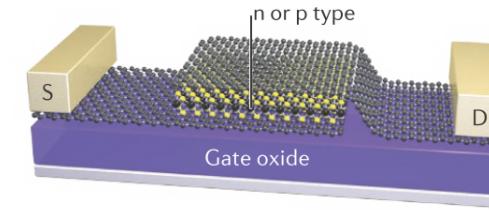
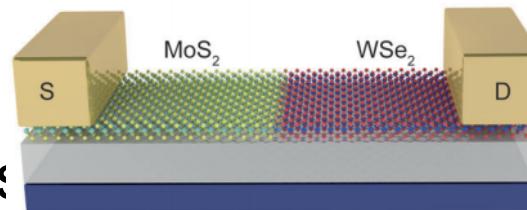
# 2DLM and van der Waals heterostructures

- 2d material types >1000



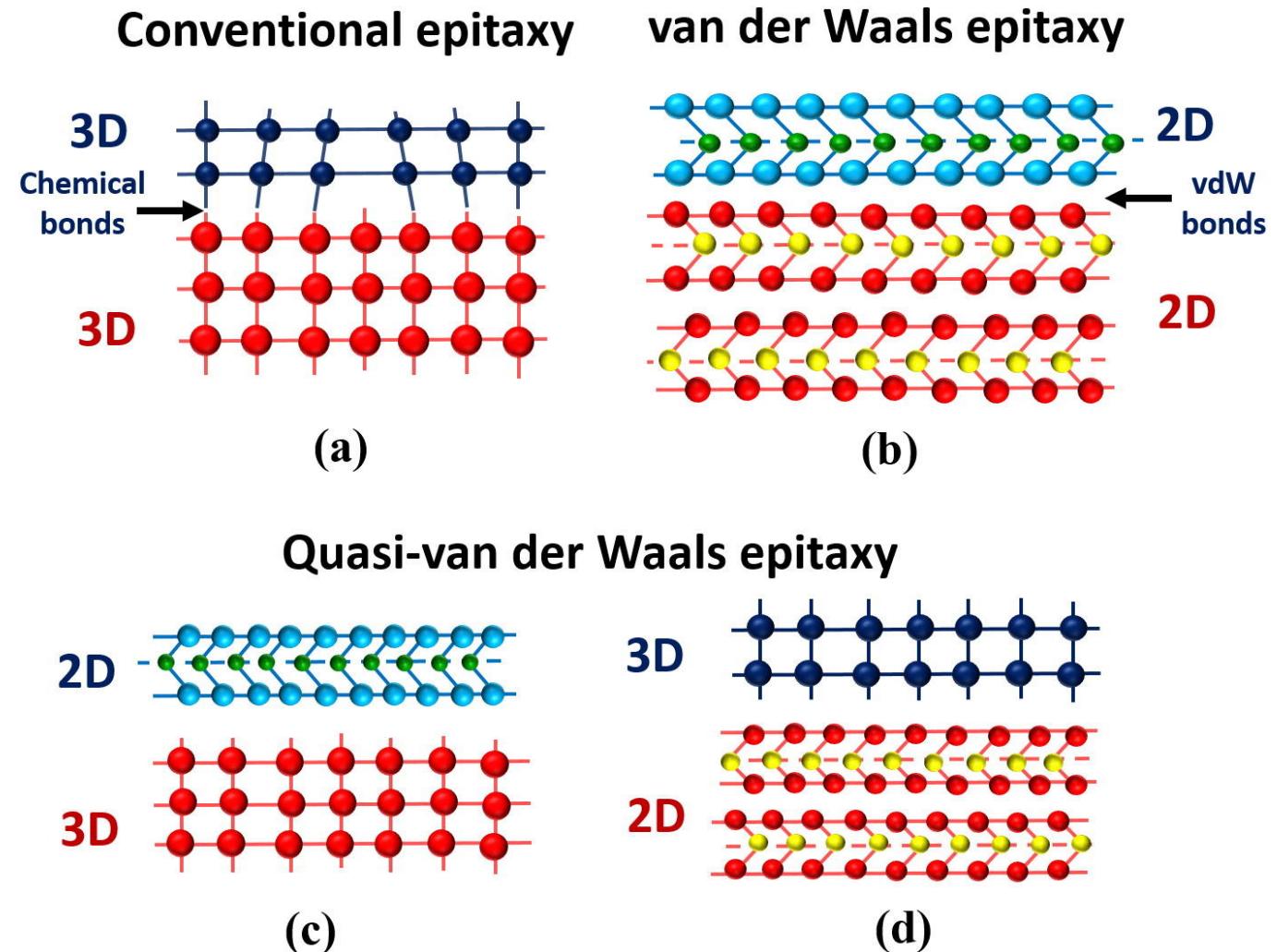
# Motivation and challenges

- Control
  - Generation
  - Transportation
  - Recombination
- Unique electronic and photo-electronic devices
  - Ultrathin
  - High power
  - Flexible devices
  - Straintronics
- Challenge
  - Scalable synthesis

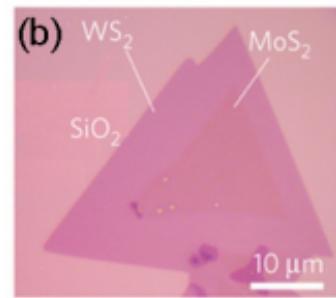
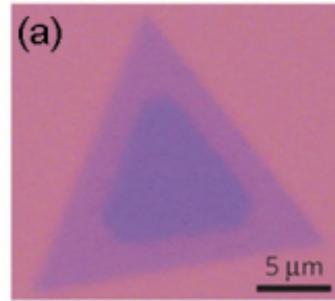


# Conventional vs van der Waals epitaxy

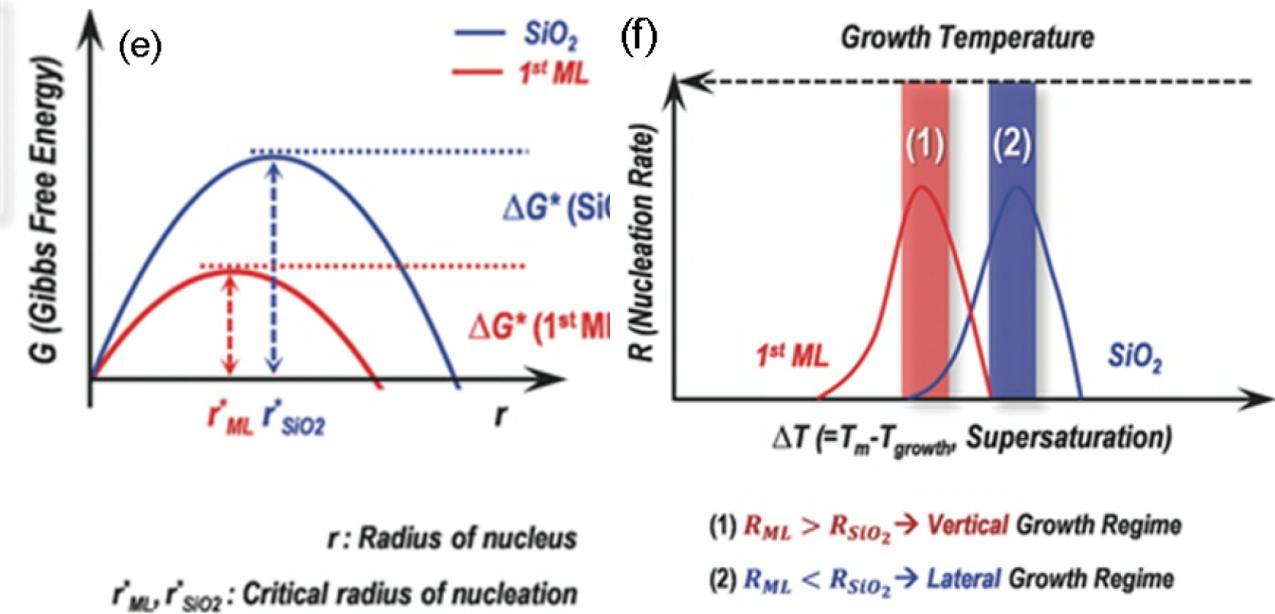
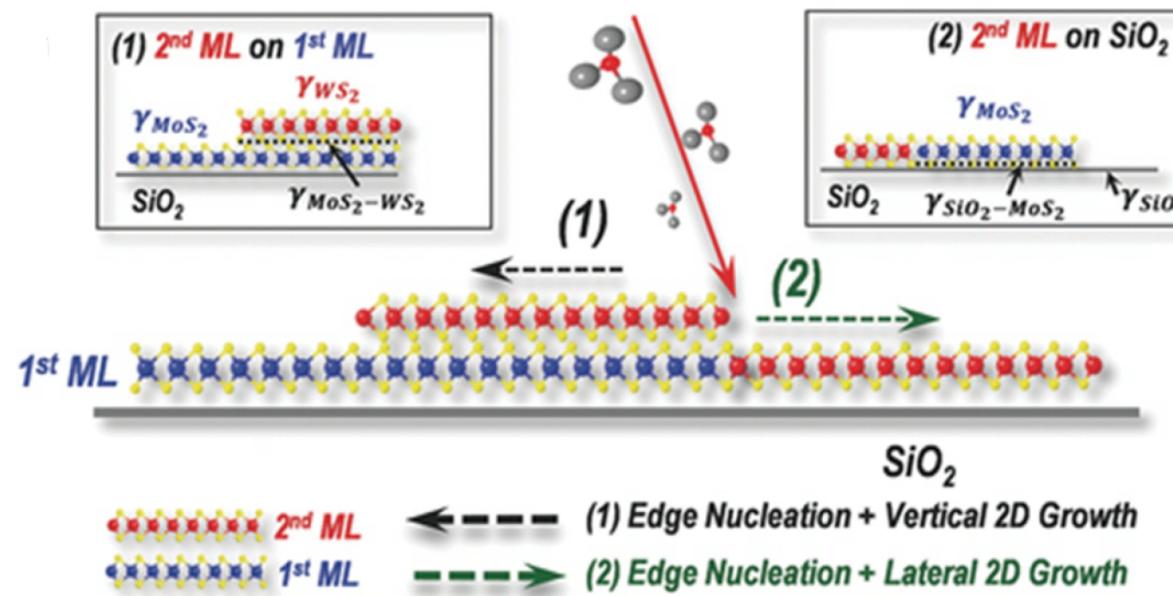
- Conventional
  - chemical bonds determine
    - lattice matching
    - Orientation
- vdW
  - Weak intermolecular/interionic coulombic interactions
- QvdW
  - 2d onto 3D



# Lateral and Vertical heterostructures



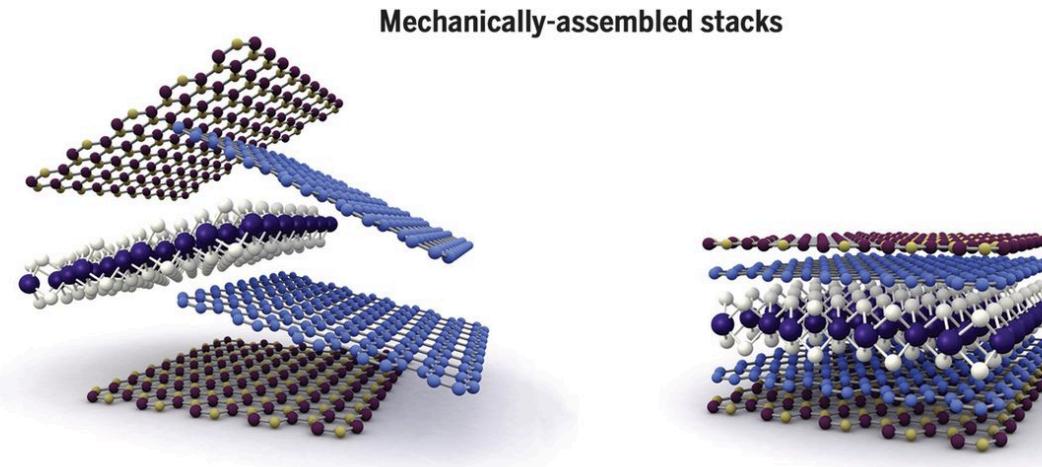
(d)



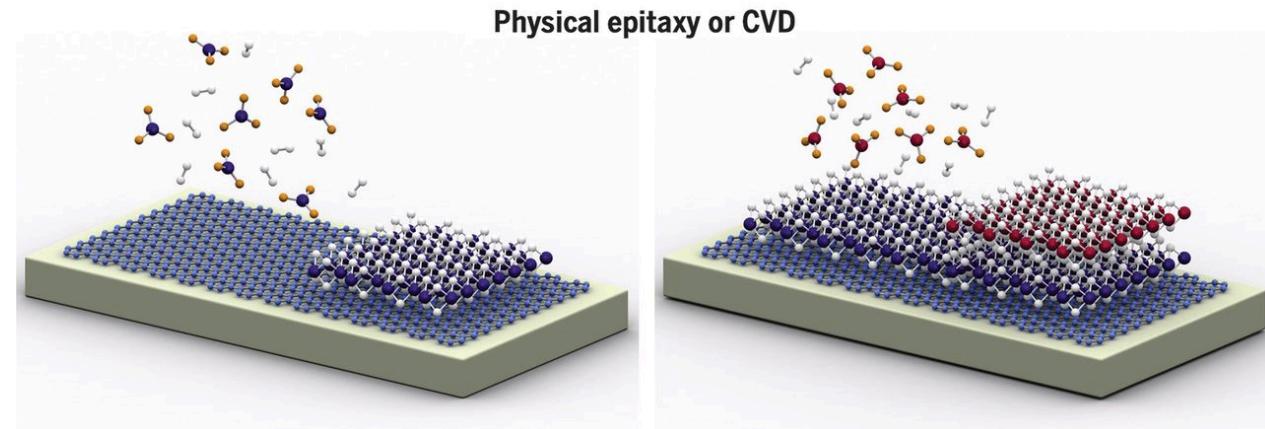
# Assembly Techniques

# Assembly of 2D materials and heterostructures

- Various assembly techniques
- Their Comparison
- Stacking with a twist



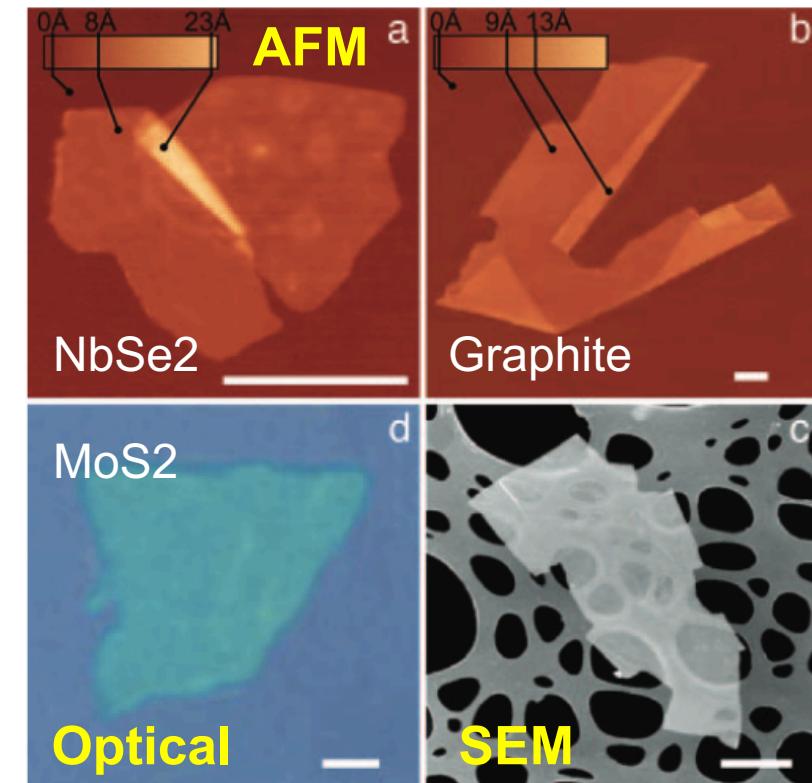
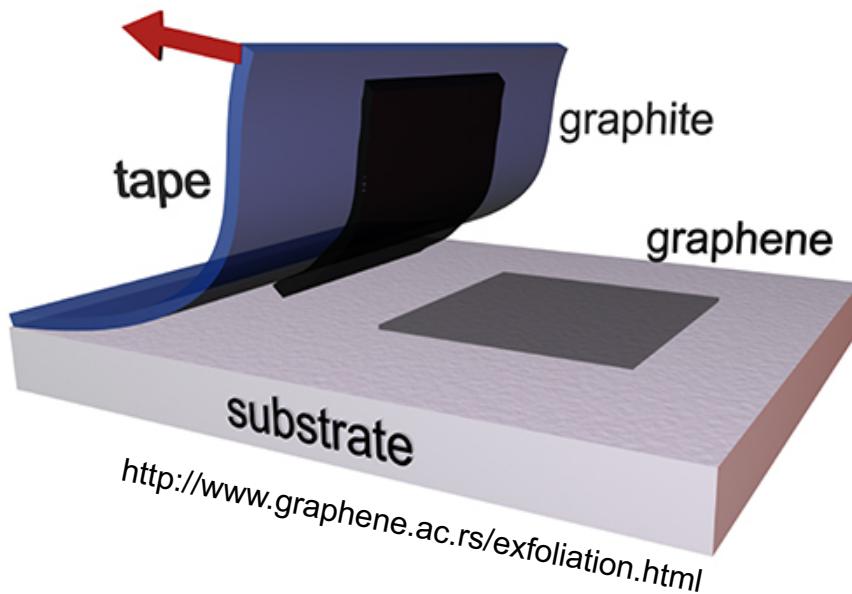
Mechanically-assembled stacks



Physical epitaxy or CVD

# Mechanical exfoliation

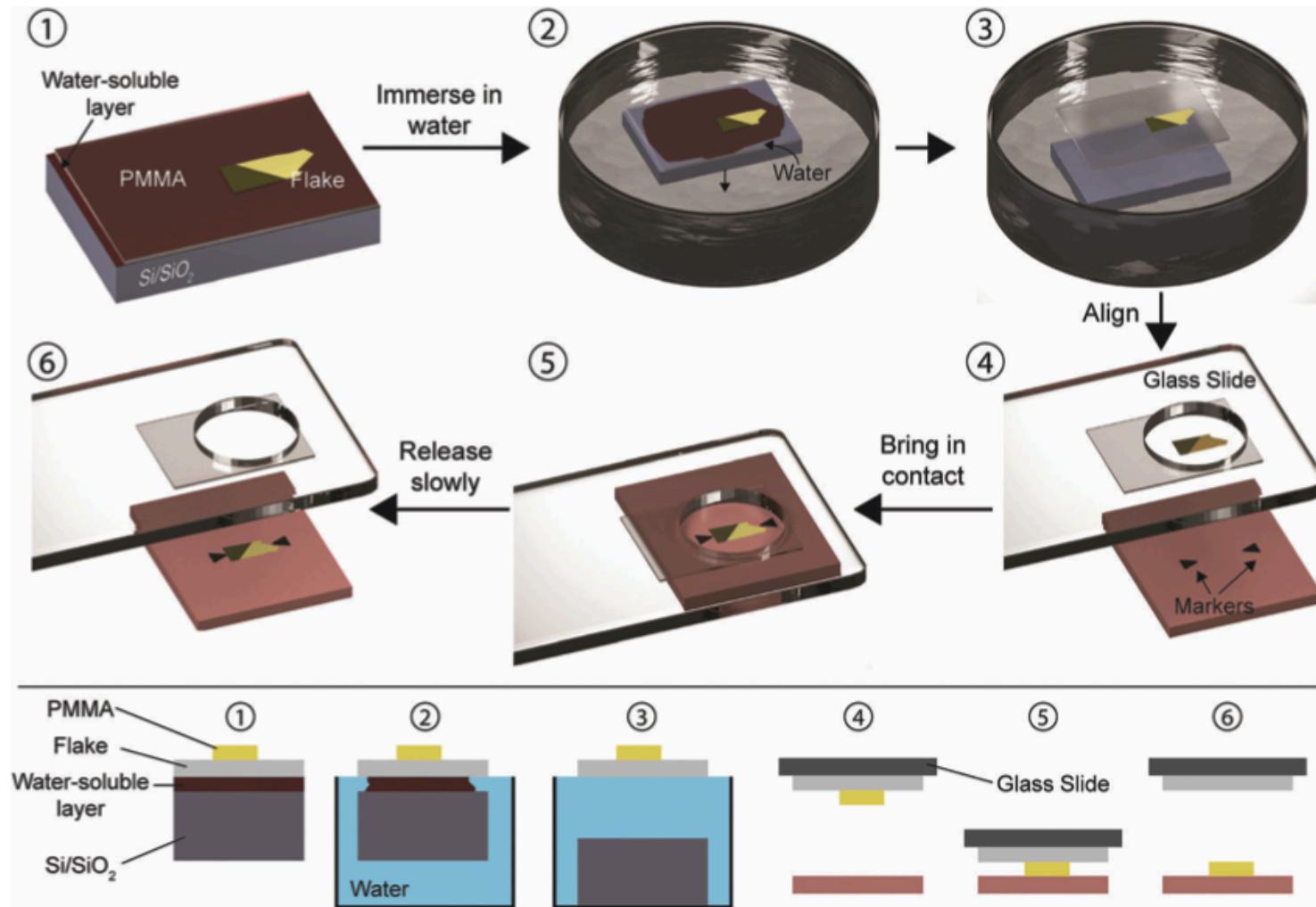
- \*First demonstration of graphene in 2004
- Yields highest quality material
- Scalability is an issue (quantity and size of flakes)
- Nevertheless, fundamental studies



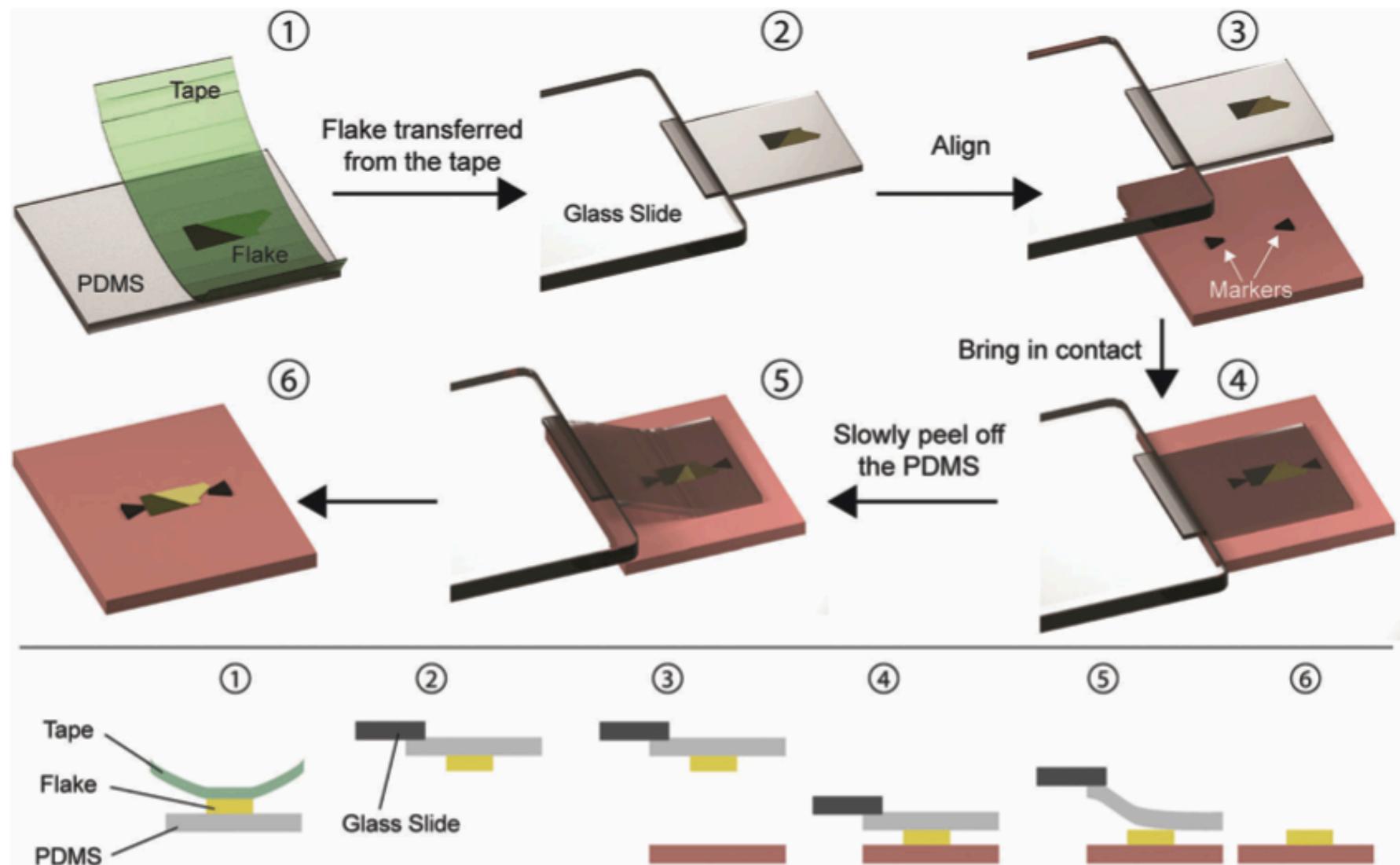
K. S. Novoselov *et. al.*, PNAS (2005), 102 (30) 10451-10453

Another example:  
**Micromechanical cleavage:** A fresh surface of layered crystal rubbed against another solid surface

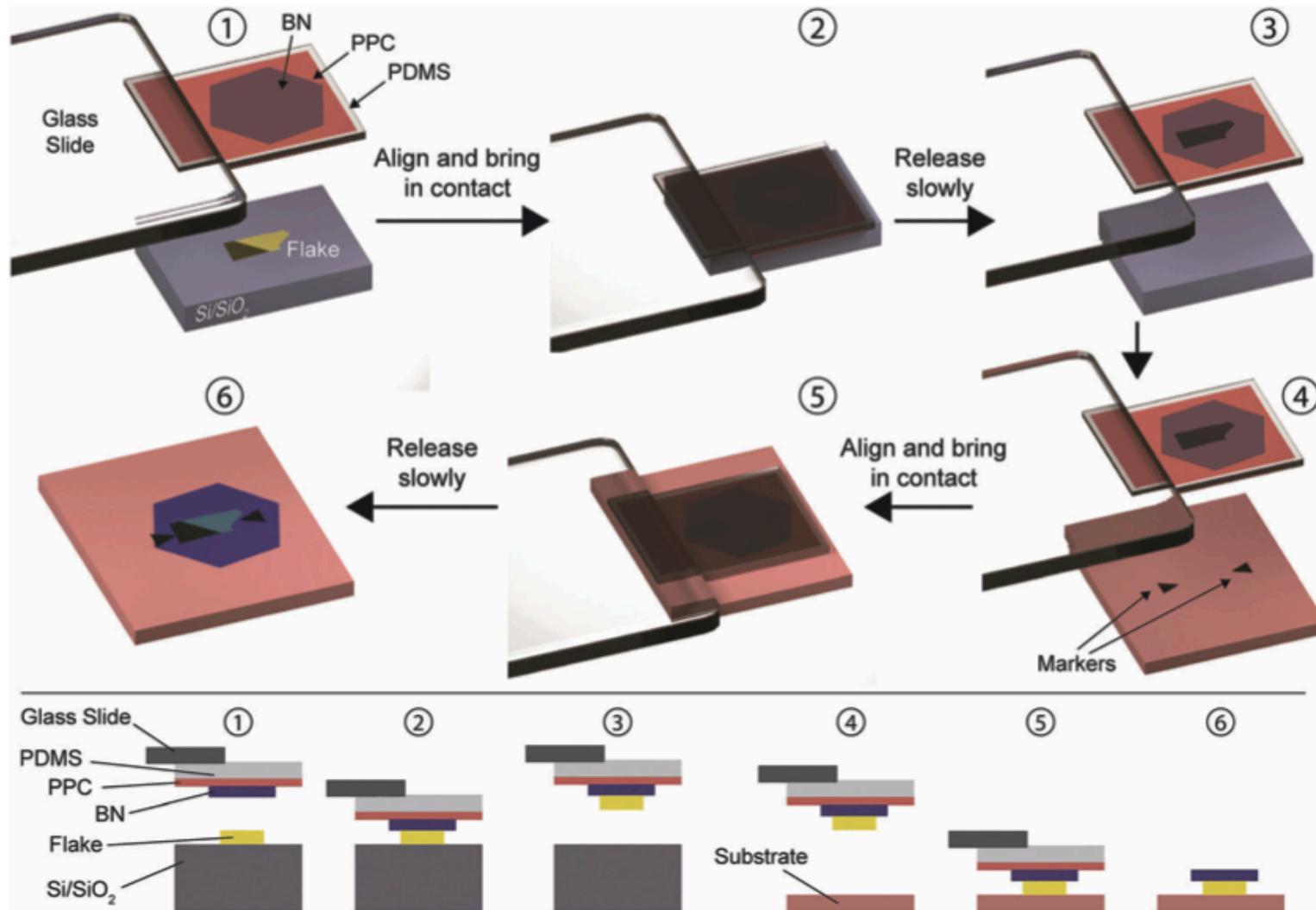
# PMMA carrying layer transfer



# PDMS deterministic transfer method



# van der Waals pick-up method

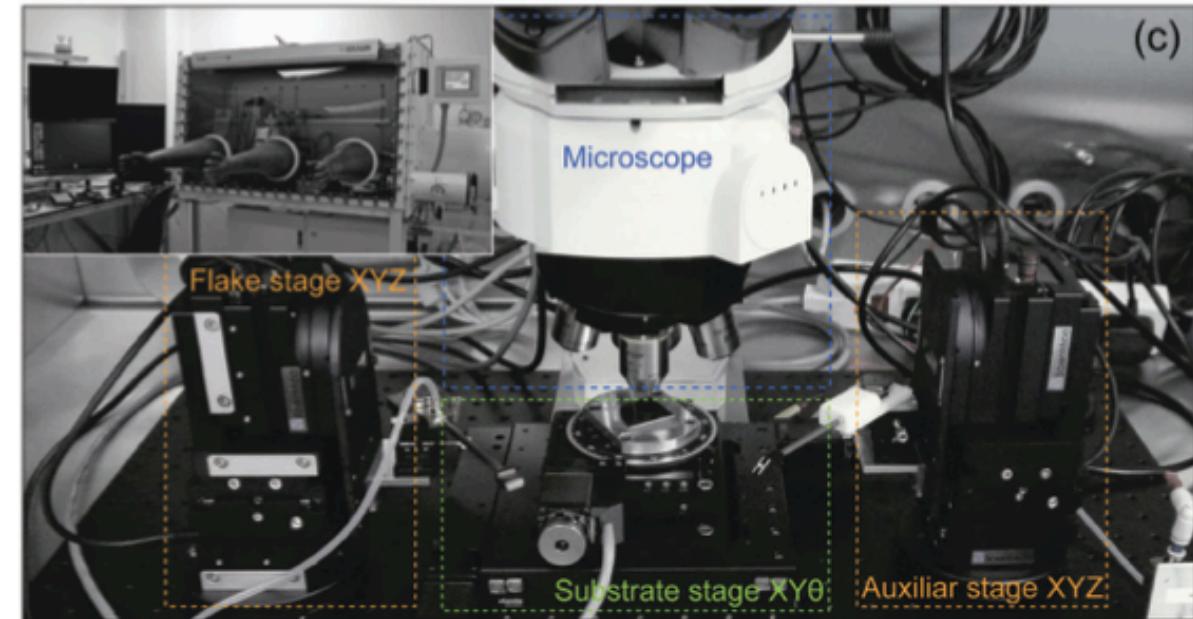
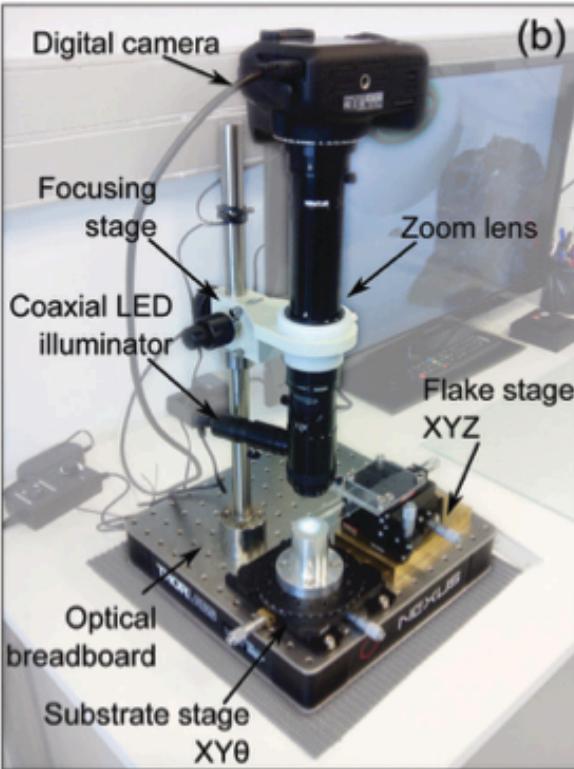


# Comparison of various techniques

**Table 1** Comparison between the different deterministic placement methods. Qualitative comparison in terms of cleanliness, easiness and speed between the different deterministic placement methods described in the text. Comments about their main drawbacks are also included in the table

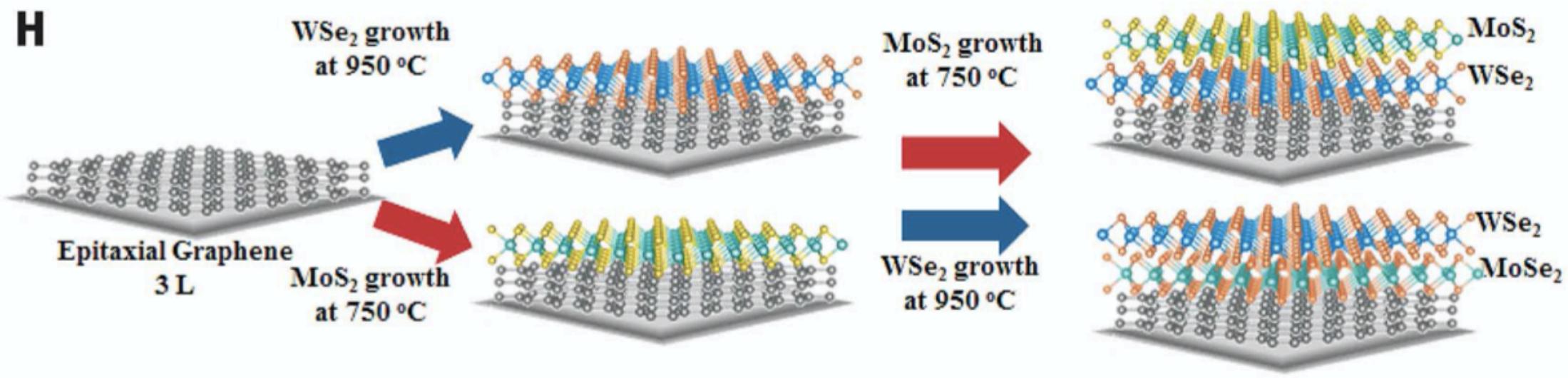
Method	Cleanliness	Easiness	Speed	Notes
PMMA carrier layer	***	***	***	Spin-coating is needed, direct contact with polymer, it can transfer large-area flakes.
Elvacite sacrificial layer	*	***	***	Capillary forces, spin-coating is needed, direct contact with polymer.
Wedging	*	**	***	Capillary forces, dip-coating is needed, difficult alignment, direct contact with polymer, transfer over curved or uneven surfaces is possible.
<b>PDMS dry transfer</b>	***	*****	*****	Direct contact with polymer.
van der Waals pick-up	*****	*	**	Spin-coating is needed, several steps involved, only works to transfer heterostructures, direct contact with the polymer only for the topmost layer.

# Transfer setups in the lab



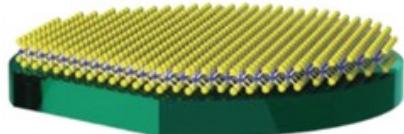
# CVD growth

- Growth of individual layers
- Different deposition conditions for different layers



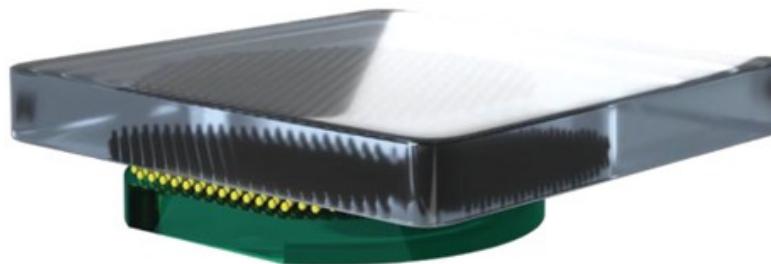
# Example of a wafer-scale technique

a



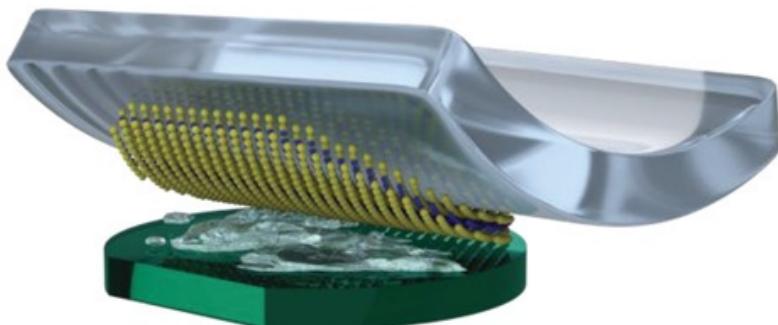
Wafer-scale growth of  $\text{MoS}_2$  on  
7.62 cm - sapphire substrate

b



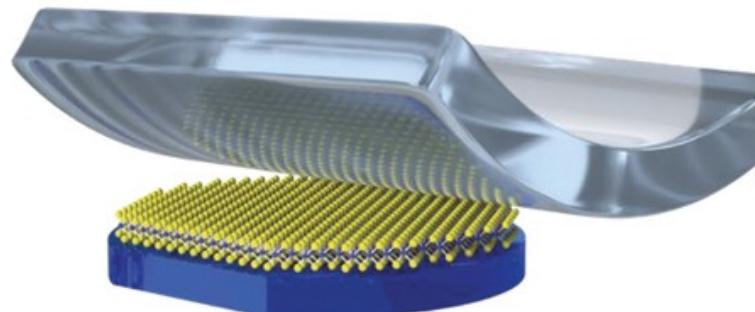
PDMS/ $\text{MoS}_2$  on sapphire substrate

c



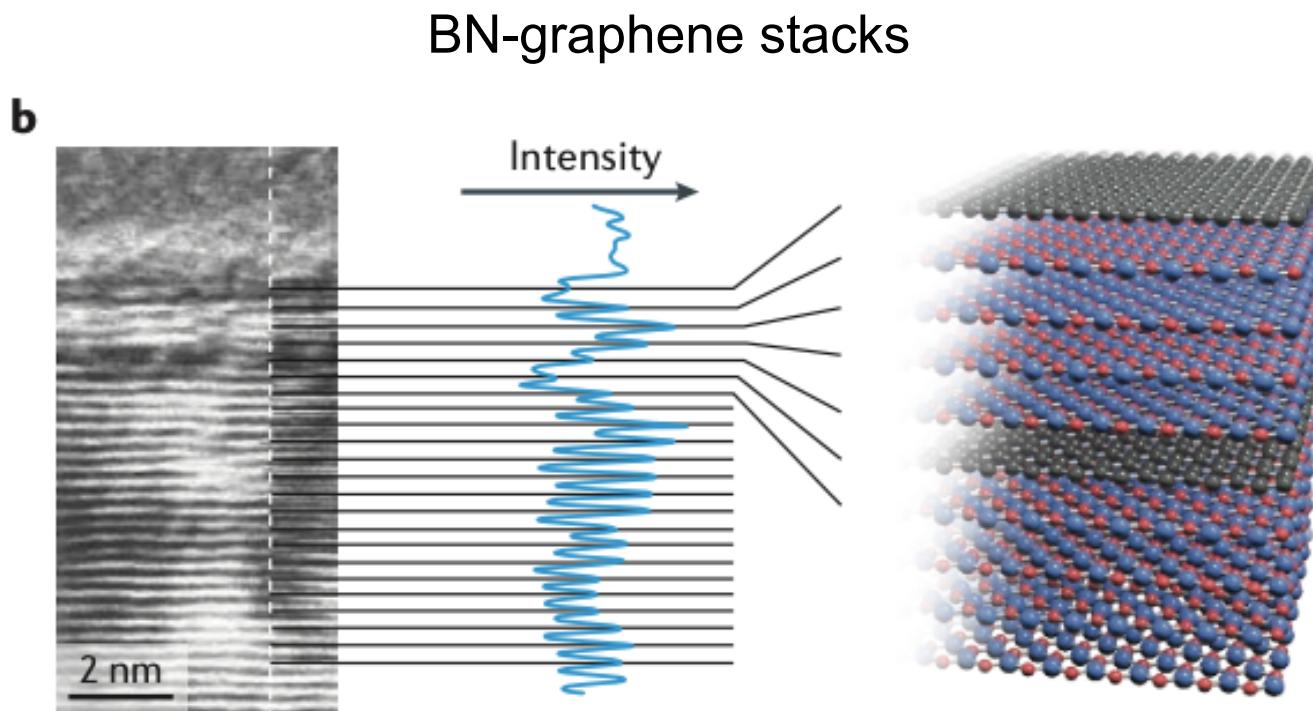
Water-assisted lift-off process

d

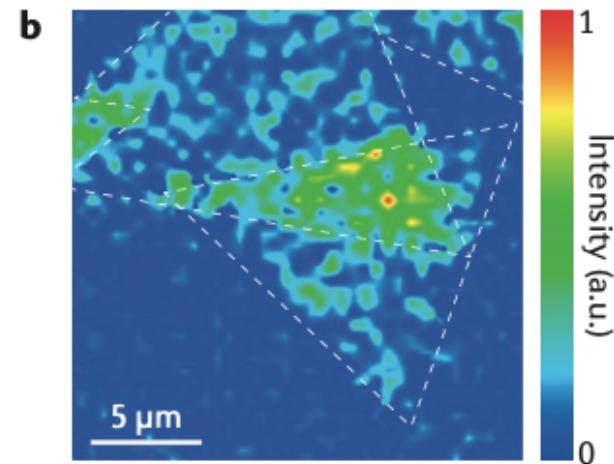
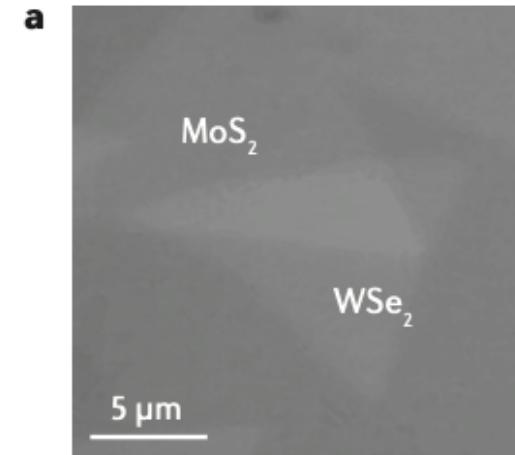


Complete dry-transfer of  $\text{MoS}_2$   
on  $\text{SiN}_x$  wafer

# Example heterostructure: Multilayer stacks

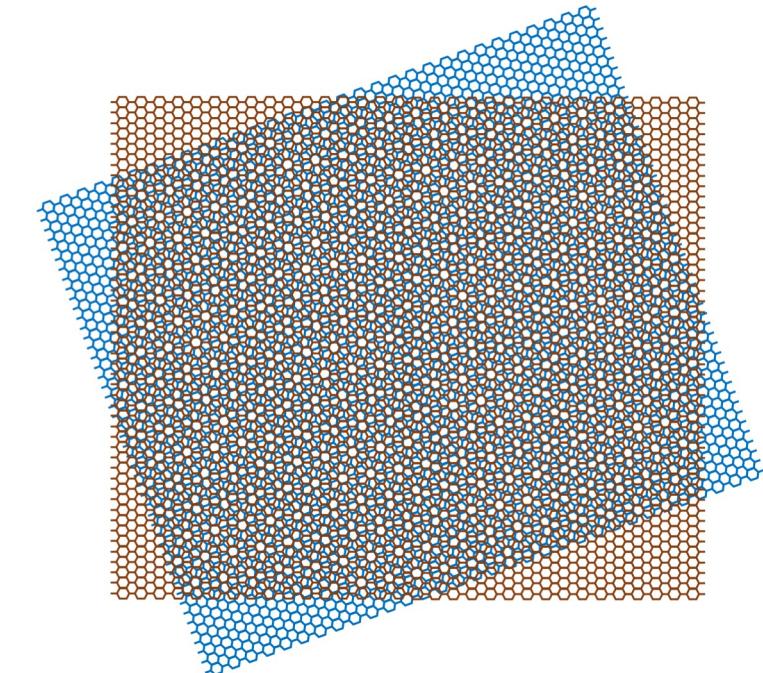
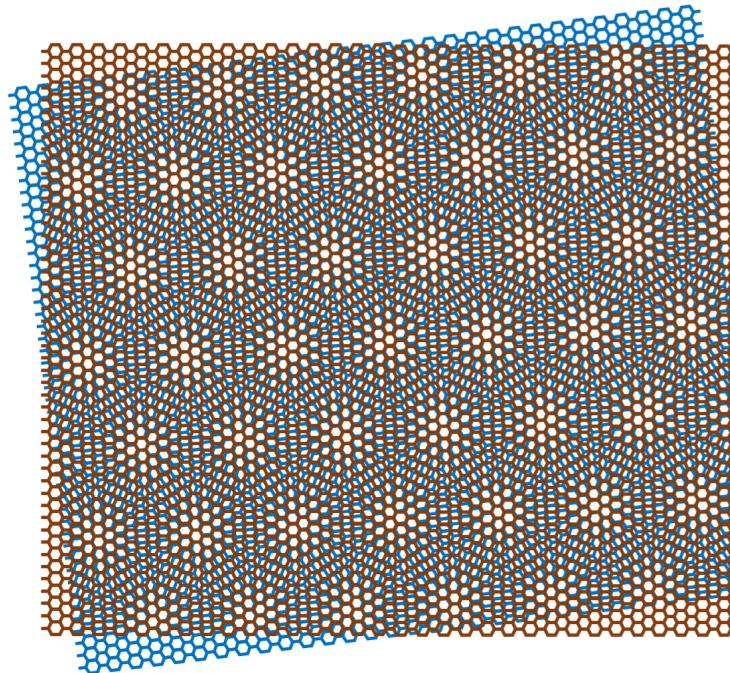
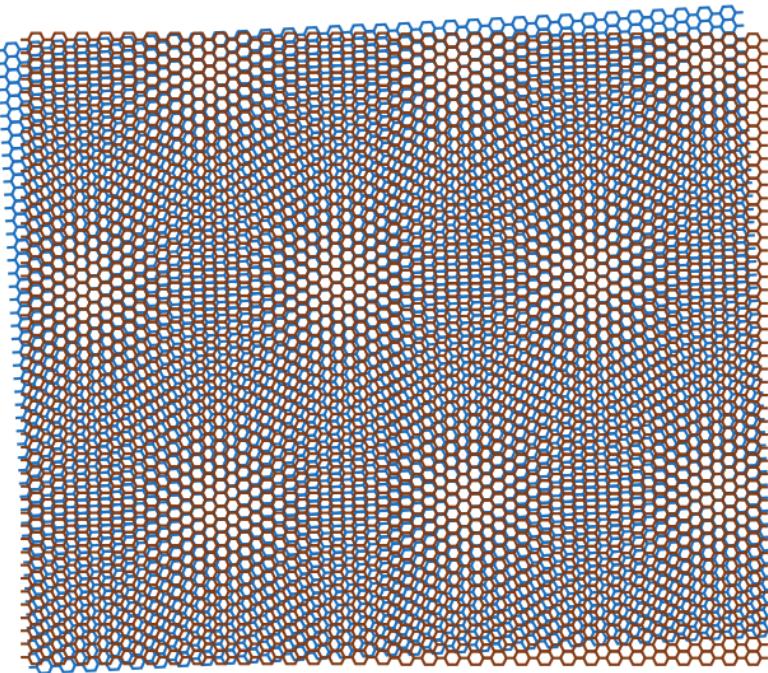


$\text{MoS}_2$ -WSe<sub>2</sub>

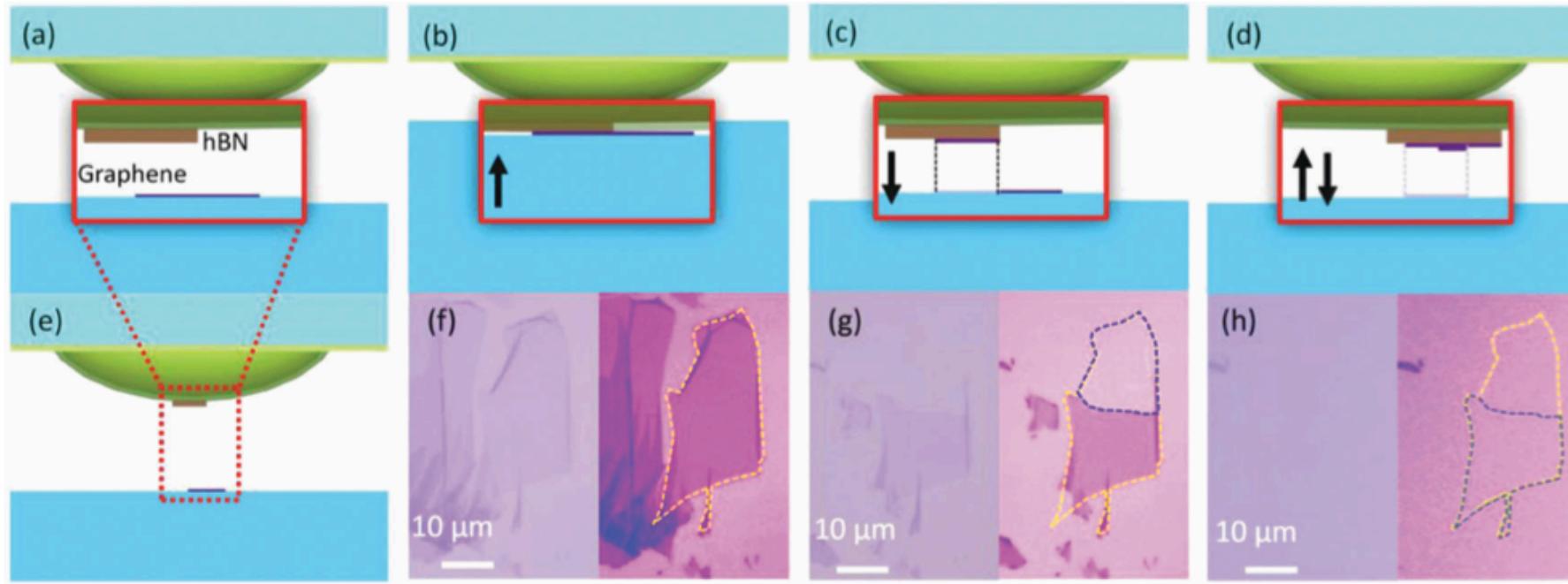


Coupling of  $\text{A}_{1g}$  Raman mode

# Stacking with a twist ☺

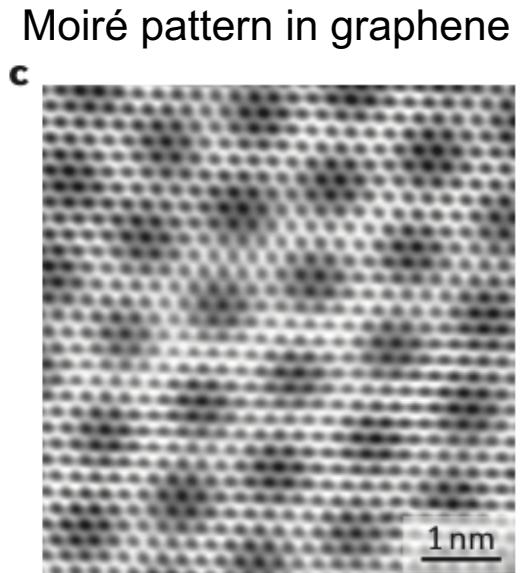


# Control of twist angle

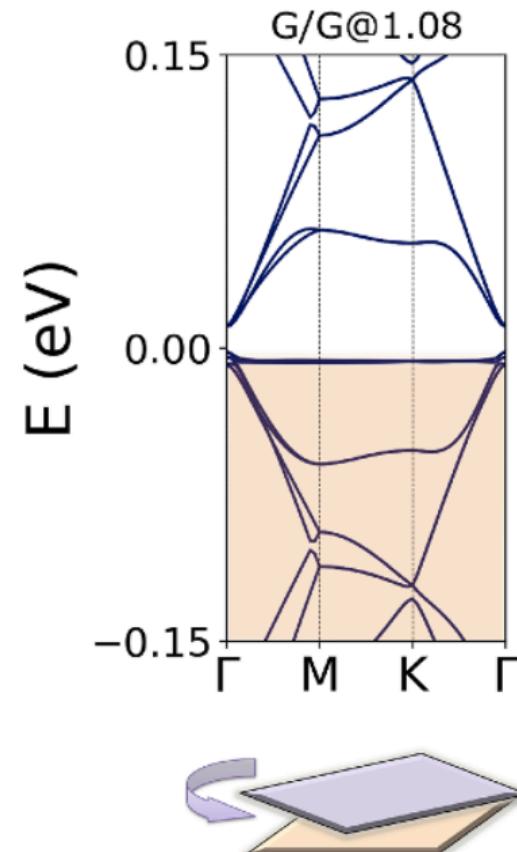


- One layer is rotated w.r.t. another
- New control knob
  - Removes symmetry restrictions (imposed by thermodynamic stacking)
- **Fabrication using variation of vdW pick-up method**

# Twistronics



- Hosts exotic Moiré physics
- Quantum tunnelling of electrons between layers
  - Emergence of superconductivity
  - “Magic angle” ( $1.1^\circ$ )



Band structure in twisted bilayer graphene

Some examples of 2D  
heterostructures

# A quick overview

## 2D heterostructures and applications.

Heterojunction type	Layer structure	Application	Device performance	Ref
<b>Semi-metal/ semiconductor</b>	Graphene/MoS <sub>2</sub>	DNA biosensor	Detection DNA concentration 1 atto mole	Loan et al. [60]
	Graphene/WS <sub>2</sub>	Solar cells	Power conversion efficiency 3.3%	Shanmugam et al. [67]
	Graphene/WS <sub>2</sub> /graphene/ h-BN	Vertical FETs	ON/OFF ratio $>1 \times 10^6$	Georgiou et al. [75]
	Graphene/MoS <sub>2</sub>	Vertical FETs	Current density 5000 A cm <sup>-2</sup> ON/OFF ratio $>10^3$	Yu et al. [76]
	Graphene/MoS <sub>2</sub>	Vertical FETs	Current density $\sim 10^4$ A cm <sup>-2</sup> ON/OFF ratio $\sim 10^5$	Moriya et al. [77]
	Graphene/h-BN/MoS <sub>2</sub> / graphene	FETs	Electron mobility $\sim 33$ cm <sup>2</sup> /V s. ON/OFF current ratio $>10^6$	Roy et al. [68]
	Graphene/MoS <sub>2</sub> /graphene	Photodetector	External quantum efficiency 55% Internal quantum efficiency 85%	Yu et al. [80]
	Graphene/WS <sub>2</sub> /graphene	Photodetector	Photoresponsivity 0.22 A/W External quantum efficiency $\sim 30\%$	Britenall et al. [79]
	Graphene/MoS <sub>2</sub>	Photodetector	Photoresponsivity 0.1 A/W Photogain $>10^8$ Internal quantum efficiency $\sim 15\%$	Zhang et al. [89]
	Graphene/MoS <sub>2</sub>	Photodetector	Photoresponsivity $>10^7$ A/W Gain $\sim 5-10 \times 10^{10}$ Quantum efficiency $\sim 32\%$ Photoresponsivity $1 \times 10^{10}$ A/W at 130 K, $5 \times 10^8$ A/W at room temperature	Roy et al. [90]
<b>Semi-metal/insulator</b>	Graphene/h-BN/MoS <sub>2</sub> (WS <sub>2</sub> )/ h-BN/graphene	Electroluminescence	Extrinsic quantum efficiency $\sim 10\%$	Withers et al. [88]
	Graphene/h-BN	FETs	Mobility 60,000 cm <sup>2</sup> /V s	Dean et al. [42]
	h-BN/Gra./h-BN/Gra./h-BN; h-BN/Gra./MoS <sub>2</sub> /Gra./h-BN	Vertical FET	B/G/B/G/B: ON/OFF ratio 50 B/G/M/G/B: ON/OFF ratio $1 \times 10^4$	Britnell et al. [74]
	Graphene/h-BN/graphene	Thermoelectrical power	Seebeck coefficient $-99.3$ $\mu$ V/K $ZT = 1.05 \times 10^{-6}$	Chen et al. [92]
<b>Semiconductor/ semiconductor</b>	WSe <sub>2</sub> /MoS <sub>2</sub>	Solar cells	Power conversion efficiency 0.2%	Furchi et al. [63]
	p-WSe <sub>2</sub> /n-WSe <sub>2</sub>	CMOS	External quantum efficiency 1.5% Full logic swing voltage gain up to 38	Yu et al. [76]
	p-MoS <sub>2</sub> /n-MoS <sub>2</sub>	Solar cells	Power conversion efficiency 2.8%	Wi et al. [65]
	MoS <sub>2</sub> /p-Si	Solar cells	Power conversion efficiency 5.23%	Tsai et al. [66]
	WSe <sub>2</sub> /MoS <sub>2</sub>	Solar cells	Photoresponsivity is $\sim 2$ mA/W <sup>-1</sup> Photoresponsivity is $\sim 10$ mA/W <sup>-1</sup>	Lee et al. [64]
	WSe <sub>2</sub> /MoS <sub>2</sub>	p-n diode	External quantum efficiency 2.4%, 12% and 34% for monolayer, bilayer and multi-layer TMDs	Cheng et al. [81]
	WSe <sub>2</sub> /MoS <sub>2</sub>	Photodetector	Current rectification factor 1.2 External quantum efficiency 12%	
	Black phosphorus/MoS <sub>2</sub>	Electroluminescence	Current rectification factor $10^5$	Deng et al. [82]
	p-n diode	p-n diode	External quantum efficiency 0.3%	
	MoS <sub>2</sub> /WS <sub>2</sub>	Charge transfer	Photoresponsivity 418 mA/W Ultrafast hole transfer time $<50$ fs.	Hong et al. [93]
	WS <sub>2</sub> /MoS <sub>2</sub>	Solar cells	Open-loop voltage 0.12 V Close-loop current 5.7 pA	Gong et al. [49]
	WSe <sub>2</sub> /WS <sub>2</sub>	Solar cells	Open-loop voltage $\sim 0.47$ V Close-loop current $\sim 1.2$ nA	Duan et al. [53]
	WSe <sub>2</sub> /MoS <sub>2</sub>	Solar cells	Open-loop voltage $\sim 0.22$ V Close-loop current $\sim 7.7$ pA	Li et al. [55]
<b>Semiconductor/ insulator</b>	WSe <sub>2</sub> /MoSe <sub>2</sub>	Solar cells	Power conversion efficiency 0.12%	Gong et al. [56]
	MoS <sub>2</sub> /p-Ge	Band-to-band tunneling FET	Subthreshold swing minimum of 3.9 mV/decade, average 31.1 mV/decade	Sarkar et al. [78]
	MoS <sub>2</sub> /p-Si	Solar cells	External quantum efficiency 4%	Lopez Sanchez et al. [83]
	MoS <sub>2</sub> /h-BN/graphene	Electroluminescence	Mobility $>45$ cm <sup>2</sup> /V s ON/OFF ratio $10^4-10^6$	Lee et al. [94]

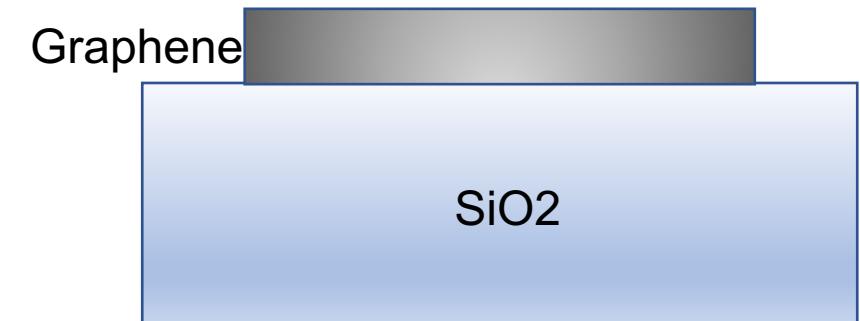
# Example 1a: High quality substrate

- SiO<sub>2</sub> is an inferior substrate for graphene



# Example 1a: High quality substrate

- SiO<sub>2</sub> is an inferior substrate for graphene
- Solution: few layers of h-BN as substrate

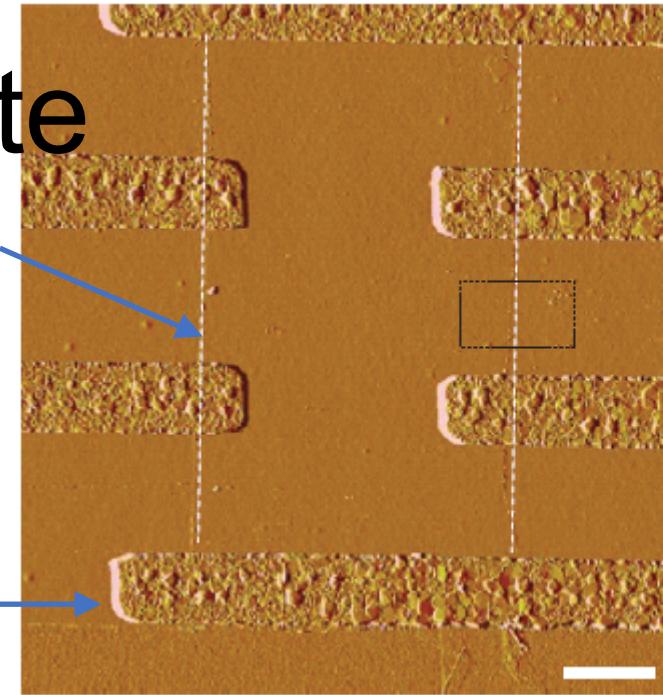


# Example 1a: High quality substrate

- SiO<sub>2</sub> is an inferior substrate for graphene
- Solution: few layers of h-BN as substrate
- Structures assembled by exfoliation

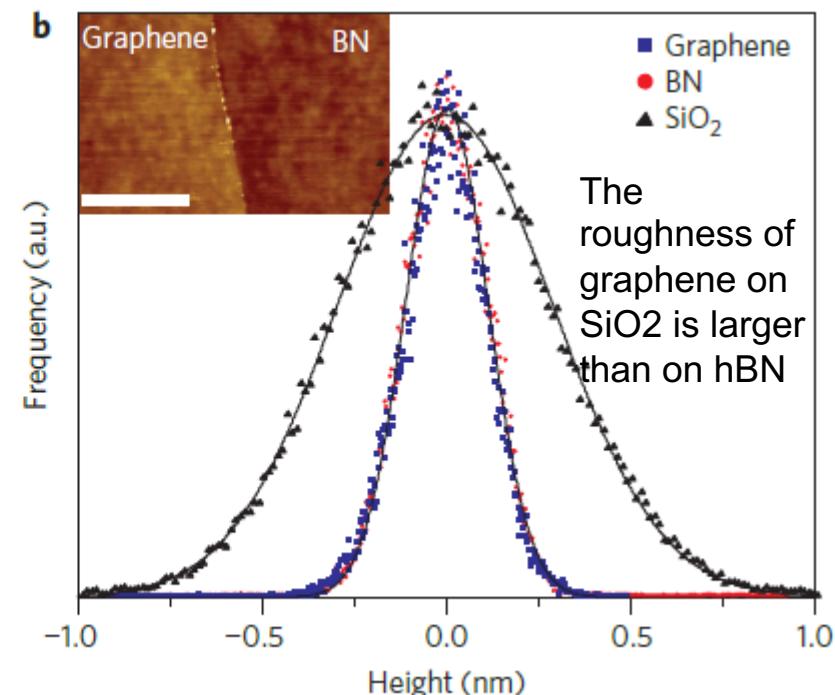
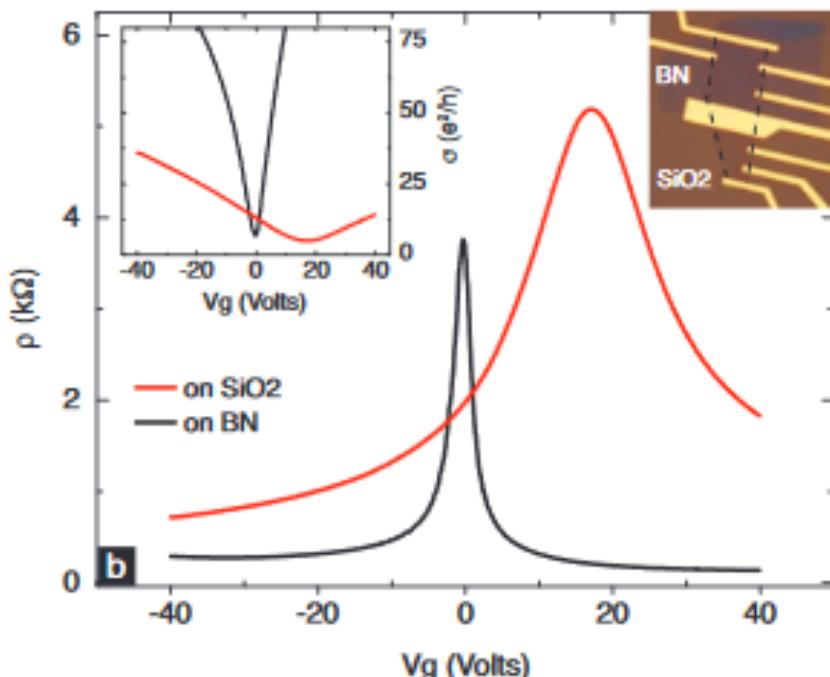
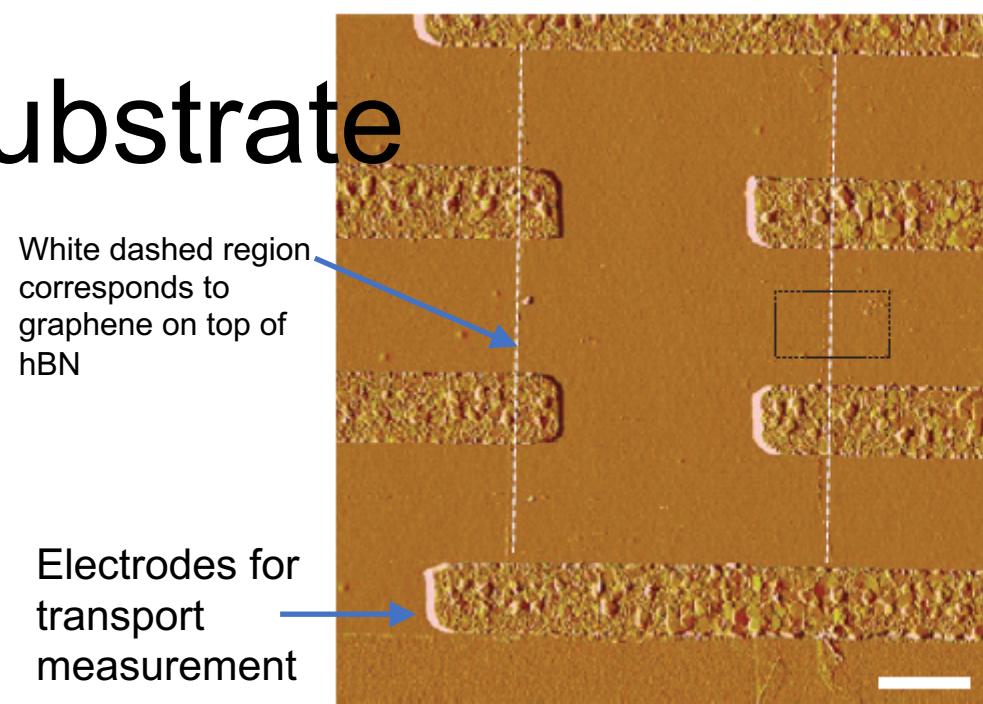
White dashed region corresponds to graphene on top of hBN

Electrodes for transport measurement



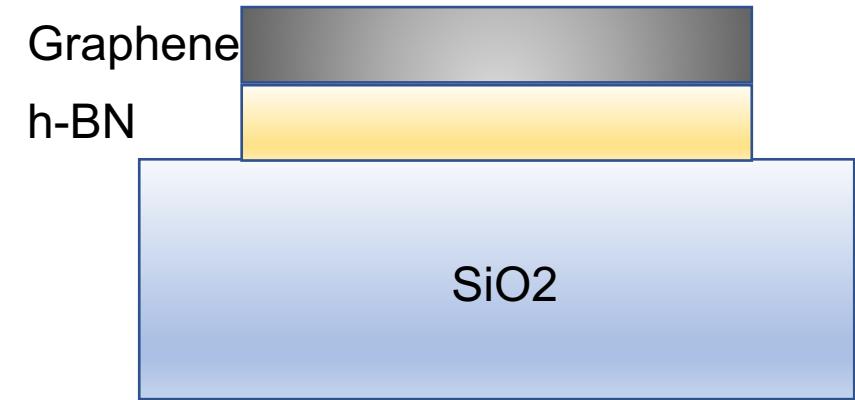
# Example 1a: High quality substrate

- SiO<sub>2</sub> is an inferior substrate for graphene
- Solution: few layers of h-BN as substrate
- Structures assembled by exfoliation
- Improvement in performance



# Example 1b: High quality substrate (CVD)

- Challenge example 1a: size and thickness



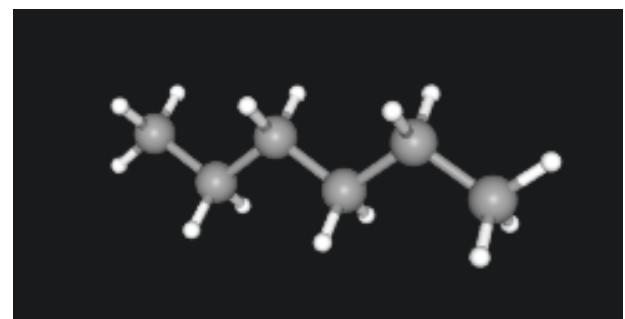
# Example 1b: High quality substrate (CVD)

- Challenge example 1a: size and thickness
- Solution: layer by layer growth

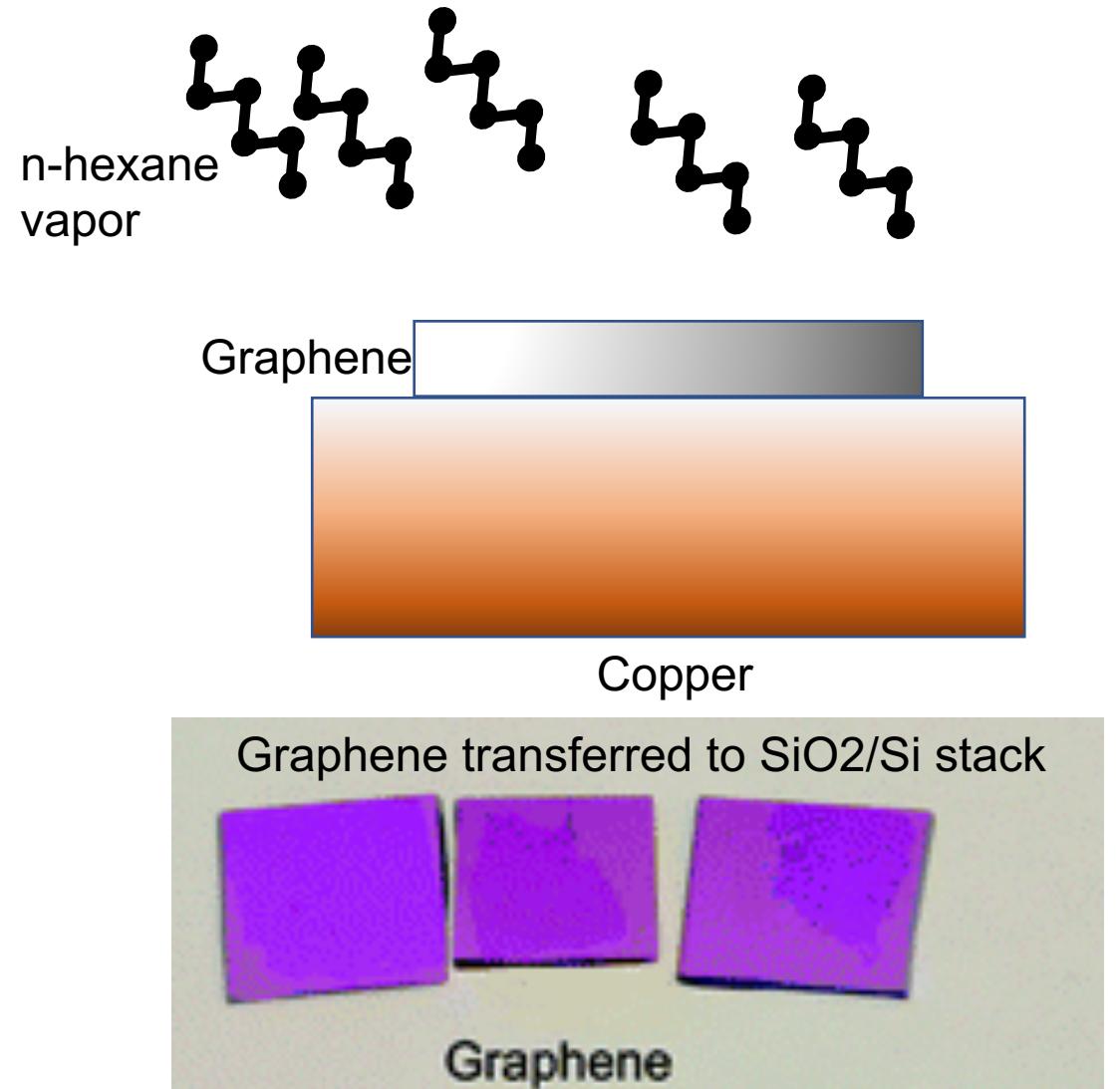


# Example 1b: High quality substrate (CVD)

- Layer 1
  - High temperature and low pressure
  - n-hexane precursor
  - Growth of graphene on Cu foil

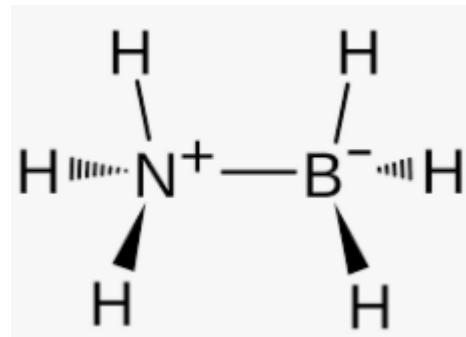


n-hexane molecule (PubChem)

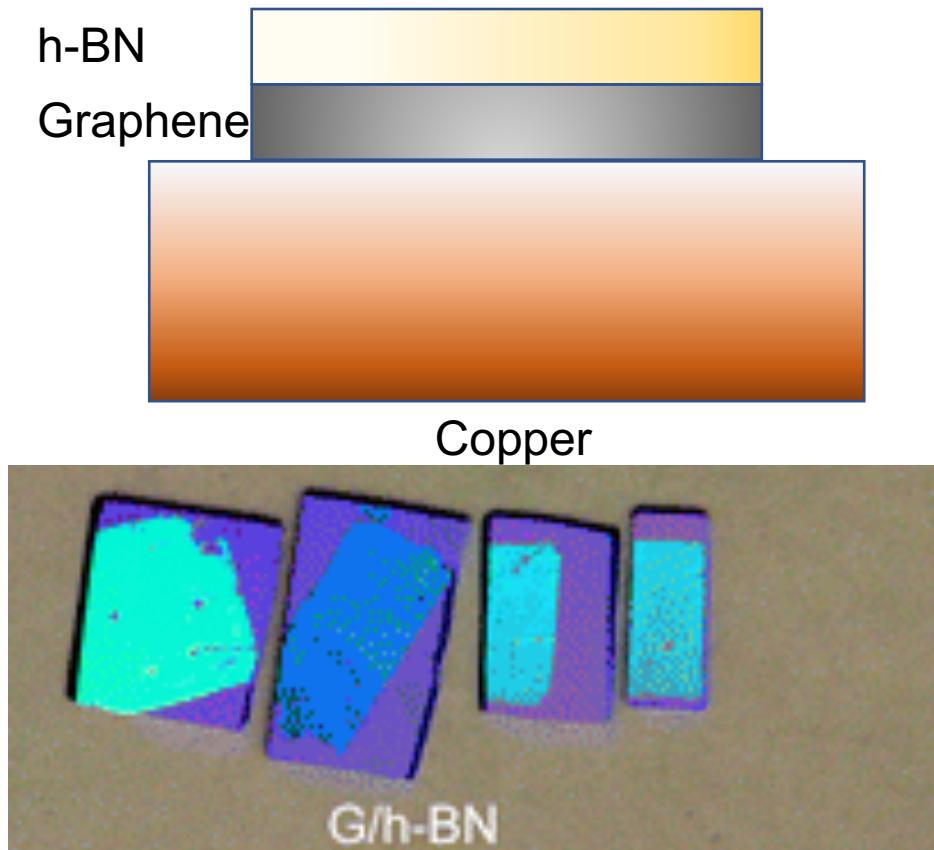


# Example 1b: High quality substrate (CVD)

- Layer 2
  - High temperature and low pressure
  - Ammonia borane precursor
  - Growth of h-BN on graphene
  - Transfer to SiO<sub>2</sub>/Si substrate

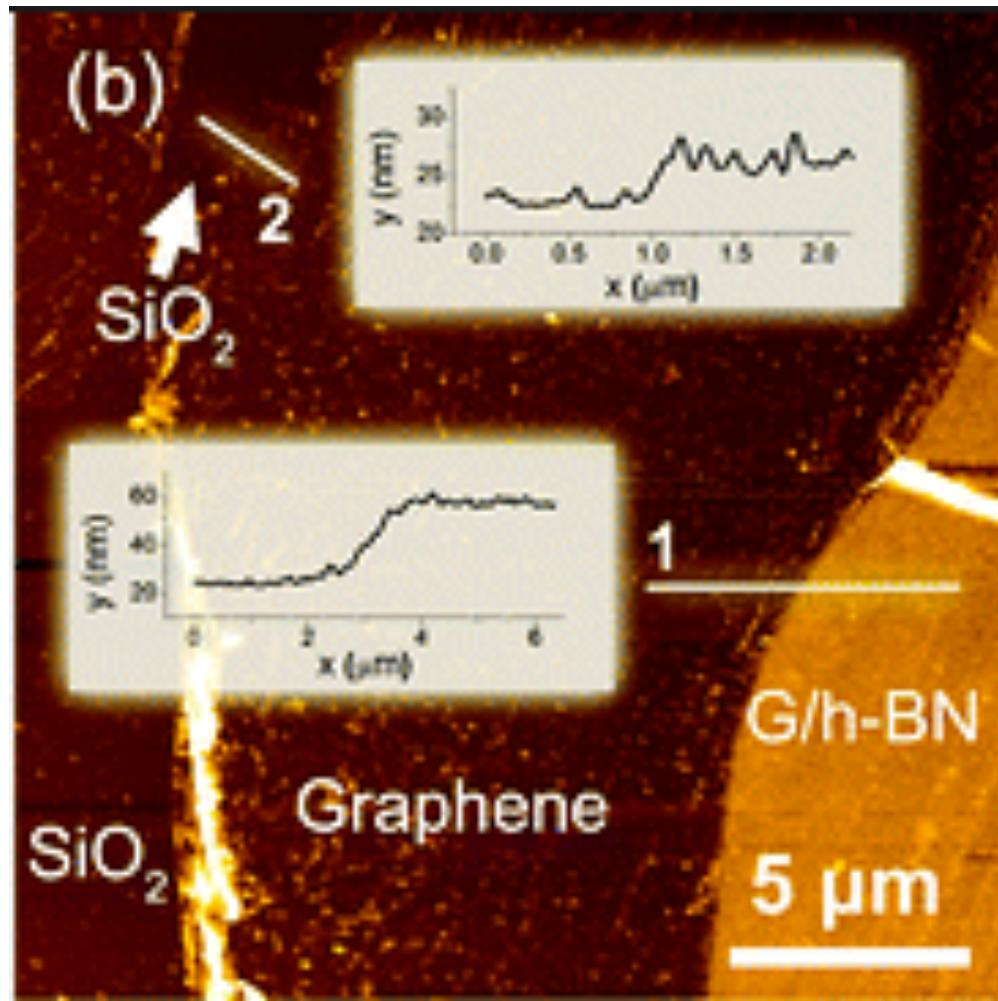


Ammonia borane (wikipedia)



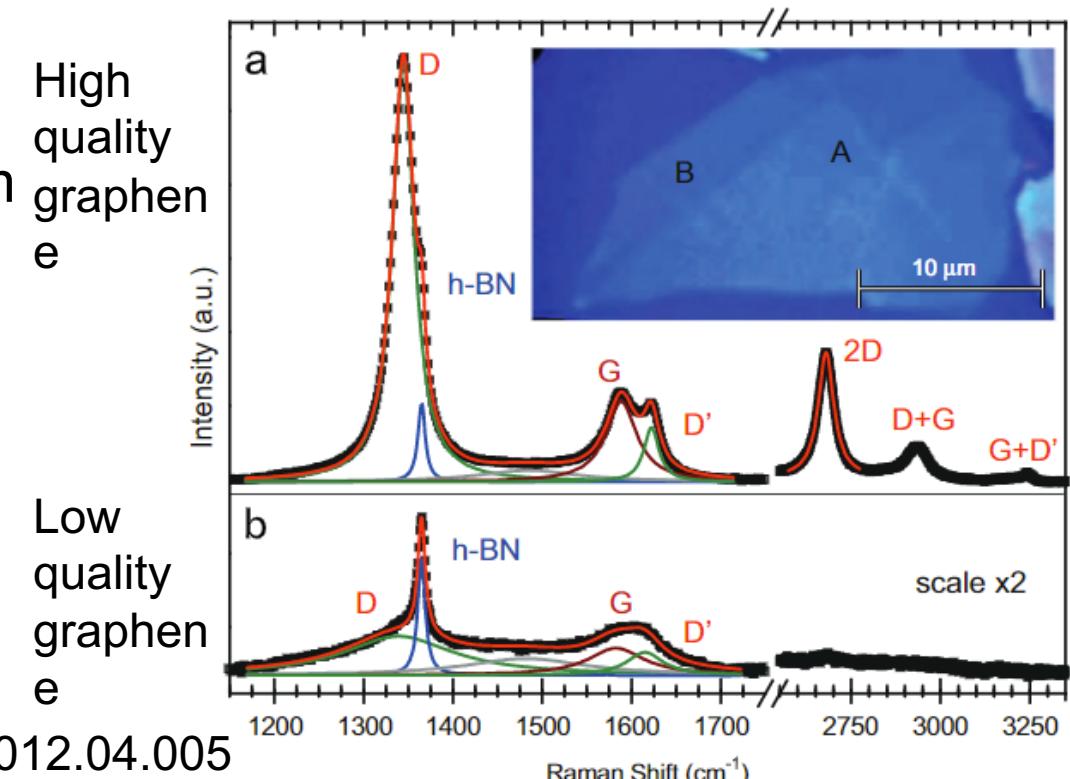
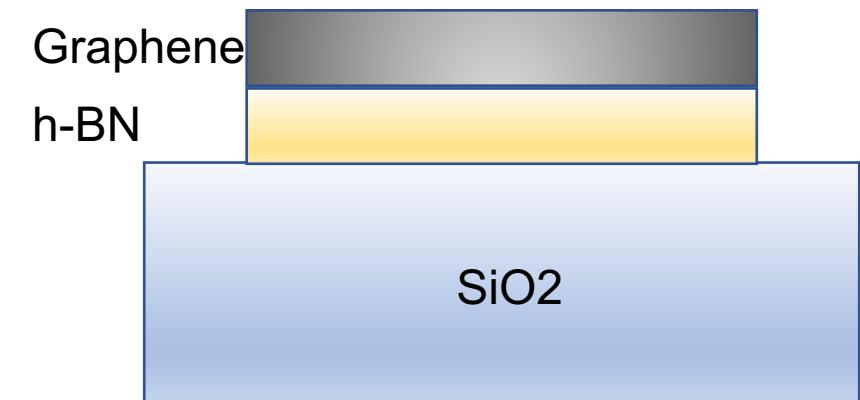
# Example 1b: High quality substrate (CVD)

- Final results



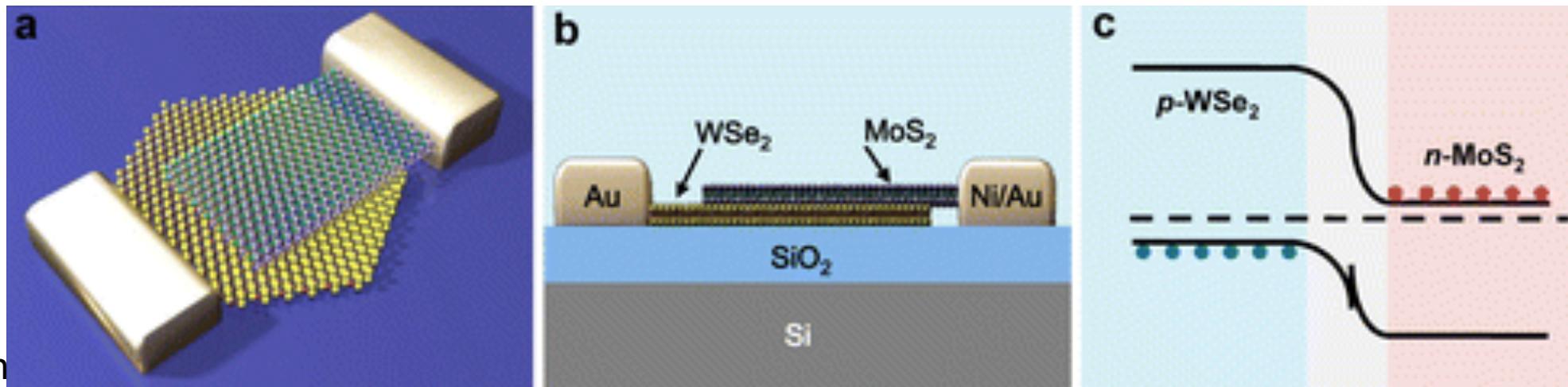
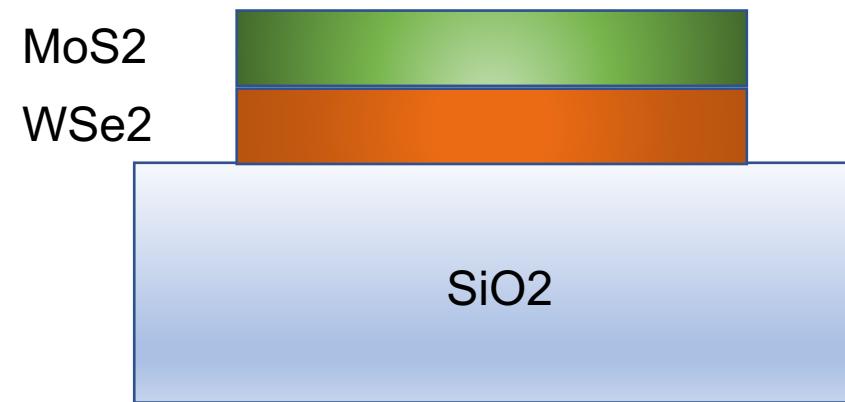
# Example 1c: High quality substrate (MBE)

- Challenge example 1b: low performance of graphene
- Solution: van der Waal epitaxy of heterostructures
  - hBN exfoliation and transfer to SiO<sub>2</sub>/Si
  - Graphene grown on hBN flakes
  - Solid carbon source
  - No dependence of Raman peaks on C atom flux
  - High D band: nanoscale domains of graphene



# Example 2: 2D heterostructure based electronics

- Challenge for atomic scale electronic is selective doping
- Solution: Vertically stacking separately doped 2D layers
- Assembled using exfoliation and transfer

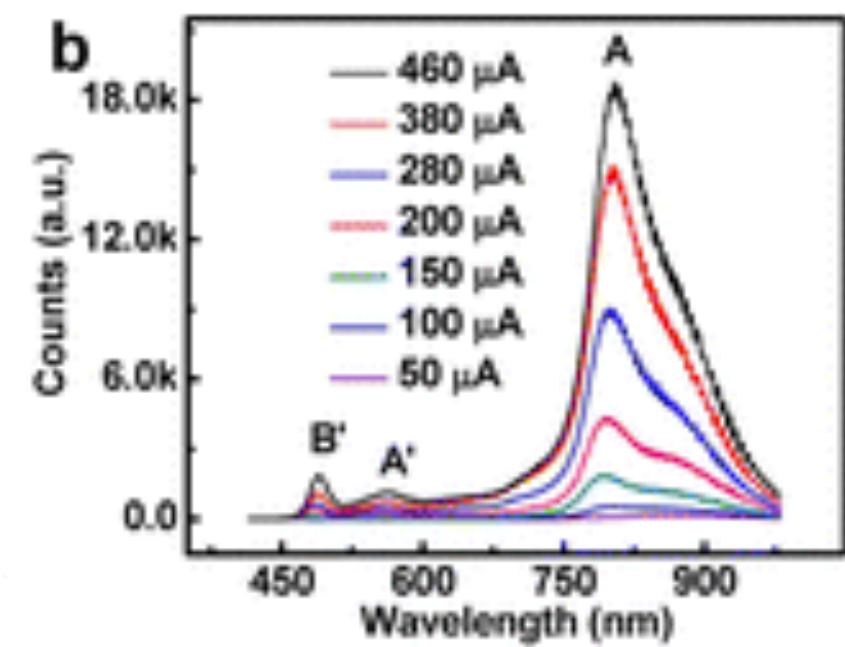
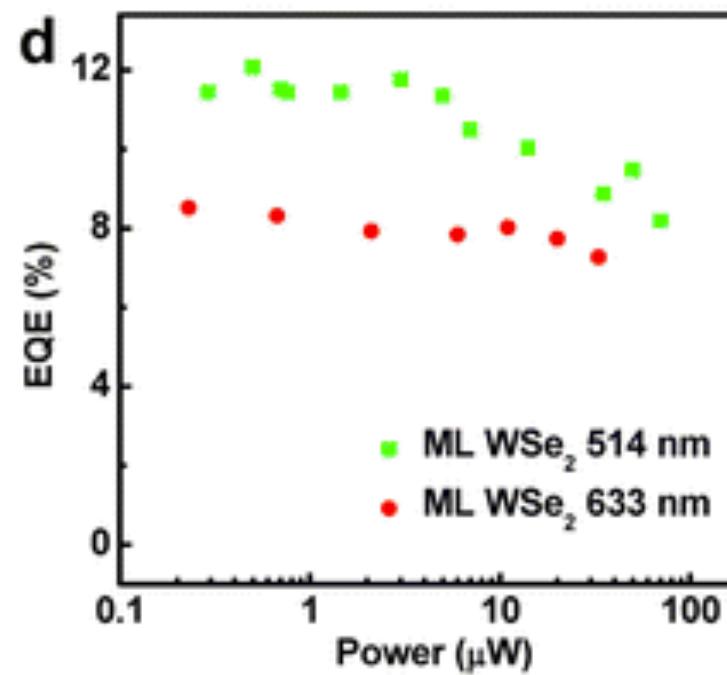
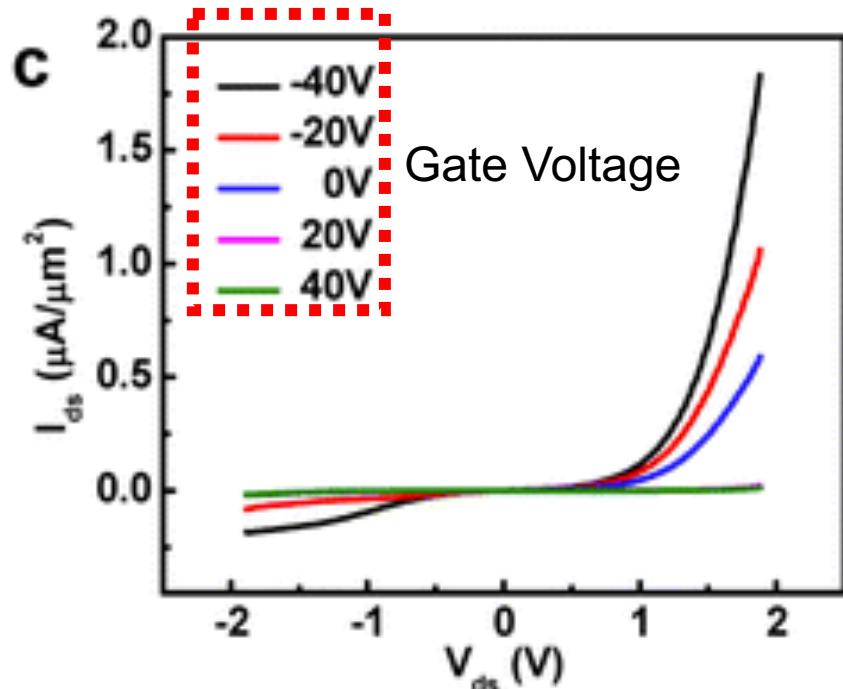
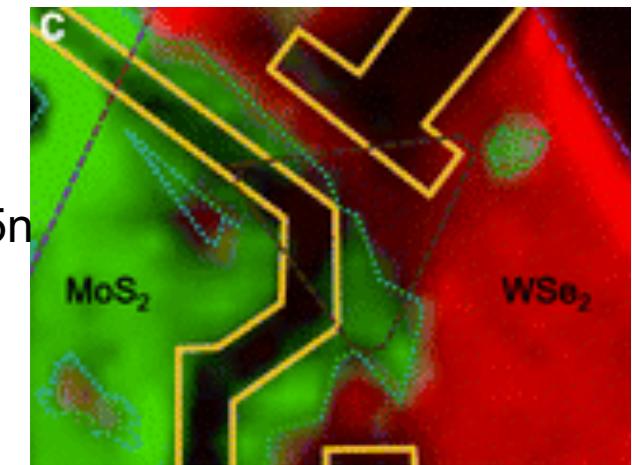


Schematic  
10.1021/nl502075n

# Example 2: 2D heterostructure based electronics

- Results
  - Ideal diode rectification
  - Photosensitive
  - Electroluminescent at high bias

PL mapping  
of MoS<sub>2</sub>  
flake on  
10.1024502075n



# Summary

- Introduction to 2D heterostructures
- Assembly techniques
- Some practical examples